6N135,6N136,JOC4502,JOC4503 Series

1Mbit/s High Speed Transistor Photo Coupler

Description

The 6N135, 6N136, JOC450X series combine an AlGaAs infrared emitting diode as the emitter which is optically coupled to a silicon high speed photo transistor in a plastic DIP8 package with different lead forming options.

A separate design between photodiode and transistor reduces the base-collector capacitance of the input transistor which improves the speed by several orders of magnitude over conventional phototransistor optocouplers.

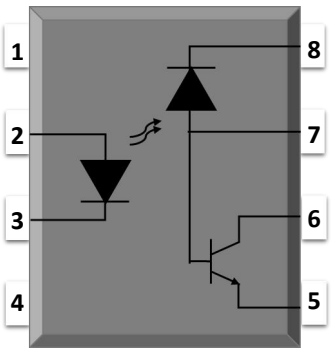
Features

- High isolation 5000 VRMS
- DC input with transistor output
- Operating temperature range - 55 °C to 100 °C
- REACH compliance
- Halogen free (Optional)
- MSL class 1
- Regulatory Approvals
  - UL
  - VDE

Applications

- Line receivers
- Telecommunication equipment
- Out interface to CMOS-LSTTL-TTL
- Wide bandwidth analog coupling
- Pulse transformer replacement
- Computer-peripheral interface

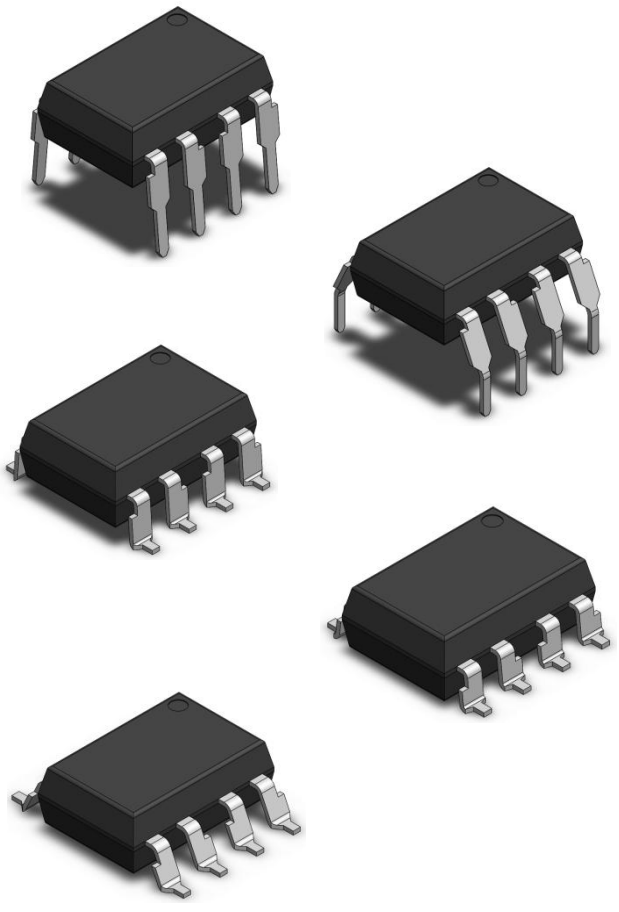
SCHEMATIC



PIN DEFINITION

1.NC	8.VCC
2.Anode	7.VB(for 6N135/6N136) NC(for JOC4502/JOC4503)
3.Cathode	6.VO
4.NC	5.GND

OUTLINE



ABSOLUTE MAXIMUM RATINGS				
PARAMETER	SYMBOL	VALUE	UNIT	Note
INPUT				
Forward Current	I_F	25	mA	
Peak Forward Current	I_{FP}	50	mA	1
Peak Transient Current	$I_{F(trans)}$	1	A	2
Reverse Voltage	V_R	5	V	
Input Power Dissipation	P_I	100	mW	
OUTPUT				
Supply Voltage	V_{CC}	-0.5~30	V	
Output Voltage	V_O	-0.5~20	V	
Output Current	I_O	50	mA	
Emitter-Base Reverse Voltage	V_{EBR}	5	V	
Base Current	I_B	5	mA	
Output Power Dissipation	P_O	100	mW	
COMMON				
Total Power Dissipation	Ptot	200	mW	
Isolation Voltage	Viso	5000	Vrms	3
Operating Temperature	Topr	-55~100	°C	
Storage Temperature	Tstg	-55~150	°C	
Soldering Temperature	Tsol	260	°C	4

Note 1. 50% duty, 1ms P.W
Note 2. ≤1μs P.W,300pps
Note 3. AC For 1 Minute, R.H. = 40 ~ 60%
Note 4. For 10 seconds

ELECTRICAL OPTICAL CHARACTERISTICS							
PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION	NOTE
INPUT(at Ta=0 to 70°C , unless specified otherwise)							
Forward Voltage	V_F	-	1.45	1.8	V	I_F=16mA	
Reverse Current	I_R	-	-	10	μA	V_R=5V	
Input Capacitance	Cin	-	60	-	pF	V=0, f=1MHz	
OUTPUT(at Ta=0 to 70°C , unless specified otherwise)							
High Level Supply Current	I_{CCH}	-	0.01	1	μA	I_F=0mA, V_O=Open, V_{CC}=15V, Ta=25°C	
		-	-	2	μA	I_F=0mA, V_O=Open, V_{CC}=15V	
Low Level Supply Current	I_{CCL}	-	200	-	μA	I_F=16mA, V_O=Open, V_{CC}=15V	
Logic High Output Current	I_{OH}	-	0.001	0.5	μA	I_F=0mA, V_O=V_{CC}=5.5V, Ta=25°C	
		-	0.01	1	μA	I_F=0mA, V_O=V_{CC}=15V, Ta=25°C	
		-	-	50	μA	I_F=0mA, V_O=V_{CC}=15V	

ELECTRICAL OPTICAL CHARACTERISTICS								
PARAMETER		SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION	NOTE
TRANSFER CHARACTERISTICS(at Ta=0 to 70°C , unless specified otherwise)								
Current Transfer Ratio	6N135	CTR	7	-	50	%	I_F = 16mA ,V_O = 0.4V, V_{CC}=4.5V, Ta=25°C	
	6N136 JOC4502 JOC4503		19	-	50			
	6N135		5	-	-		I_F = 16mA ,V_O = 0.5V, V_{CC}=4.5V	
	6N136 JOC4502 JOC4503		15	-	-			
Logic Low Output Voltage	6N135	V_{OL}	-	0.18	0.4	V	I_F = 16mA ,I_O = 1.1mA, V_{CC}=4.5V, Ta=25°C	
	6N136 JOC4502 JOC4503		-	0.25	0.4		I_F = 16mA ,I_O = 3mA, V_{CC}=4.5V, Ta=25°C	
	6N135		-	-	0.5		I_F = 16mA ,I_O =0.8mA, V_{CC}=4.5V	
	6N136 JOC4502 JOC4503		-	-	0.5		I_F= 16mA ,I_O=2.4mA, V_{CC}=4.5V	
Isolation Resistance		Riso	10^12	10^14	-	Ω	DC500V, 40 ~ 60% R.H.	
Floating Capacitance		C_{IO}	-	0.3	1	pF	V=0, f=1MHz	

ELECTRICAL OPTICAL CHARACTERISTICS

PARAMETER		SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION	NOTE
SWITCHING CHARACTERISTICS(at Ta=0 to 70°C, I_F=16mA ,V_{CC}=5V, unless specified otherwise)								
Propagation Delay Time to Logic Low	6N135	TPHL	-	0.35	1.5	μs	R_L=4.1kΩ,T_A=25°C	Fig.13
			-	-	2		R_L=4.1kΩ	
	6N136 JOC4502 JOC4503		-	0.35	0.8		R_L=1.9kΩ,T_A=25°C	
			-	-	1.0		R_L=1.9kΩ	
Propagation Delay Time to Logic High	6N135	TPLH	-	0.5	1.5	μs	R_L=4.1kΩ,T_A=25°C	Fig.13
			-	-	2		R_L=4.1kΩ	
	6N136 JOC4502 JOC4503		-	0.3	0.8		R_L=1.9kΩ,T_A=25°C	
			-	-	1.0		R_L=1.9kΩ	
Common Mode Transient Immunity at Logic High	6N135	CM_H	1000	-	-	V/μs	I_F = 0mA , V_{CM}=10Vpp, RL=4.1kΩ, T_A =25°C	Fig.14
	6N136 JOC4502		1000	-	-		I_F = 0mA , VCM=10Vpp, R_L=1.9kΩ, T_A =25°C	
	JOC4503		15000	20000	-		IF = 0mA , V_{CM}=1500Vpp, R_L=1.9kΩ, T_A =25°C	
Common Mode Transient Immunity at Logic Low	6N135	CM_L	1000	-	-	V/μs	I_F = 16mA , VCM=10Vpp, R_L=4.1kΩ, T_A =25°C	Fig.14
	6N136 JOC4502		1000	-	-		I_F = 16mA , V_{CM}=10Vpp, R_L=1.9kΩ, T_A=25°C	
	JOC4503		15000	20000	-		I_F = 16mA , V_{CM} =1500Vpp, R_L =1.9kΩ, T_A =25°C	

CHARACTERISTIC CURVES

Fig.1 Forward Current vs. Forward Voltage

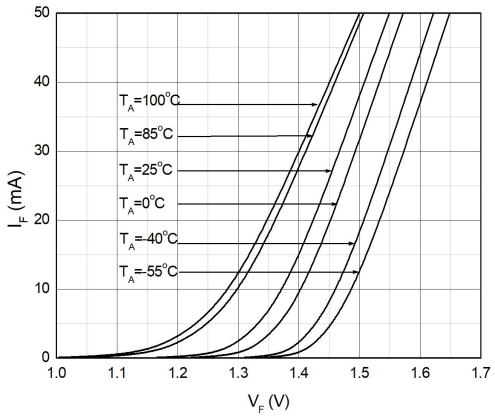


Fig.2 Forward Voltage vs. Ambient Temperature

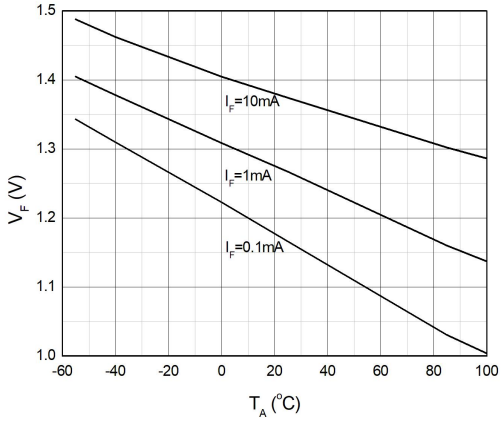


Fig.3 Input Threshold Current vs. Ambient Temperature

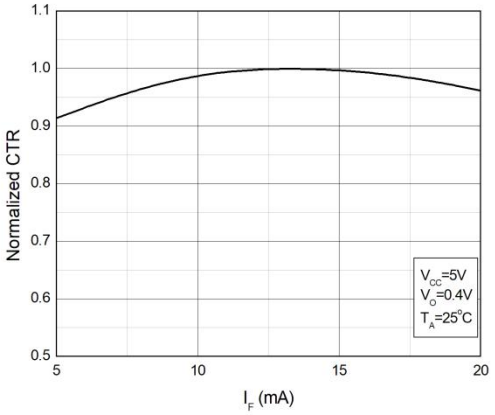


Fig.4 Input Threshold Current vs. Ambient Temperature

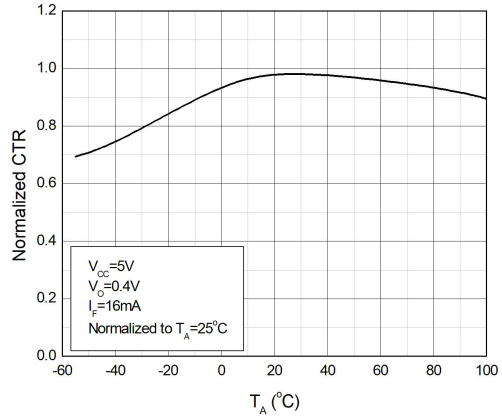


Fig.5 Low Level Output Current vs. Ambient Temperature

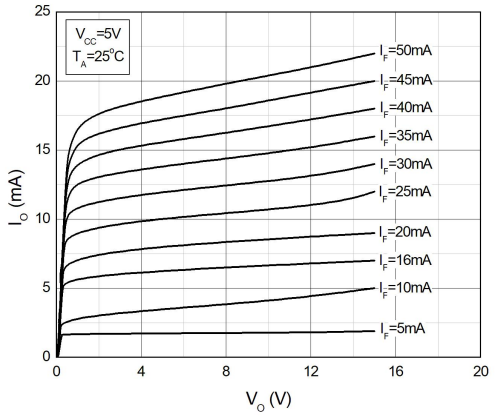
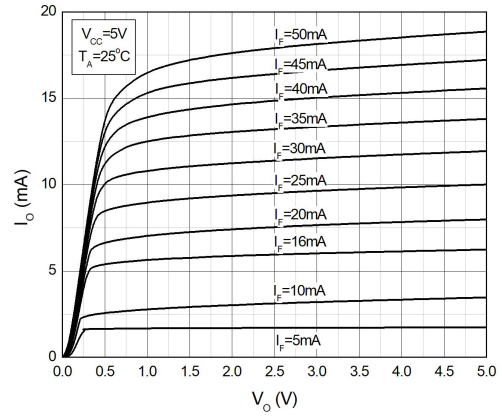


Fig.6 Low Level Output Current vs. Ambient Temperature



CHARACTERISTIC CURVES

Fig.7 Low Level Output Voltage vs. Ambient Temperature

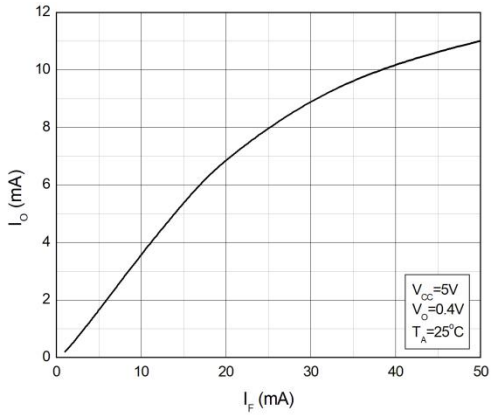


Fig.8 Low Level Output Voltage vs. Ambient Temperature

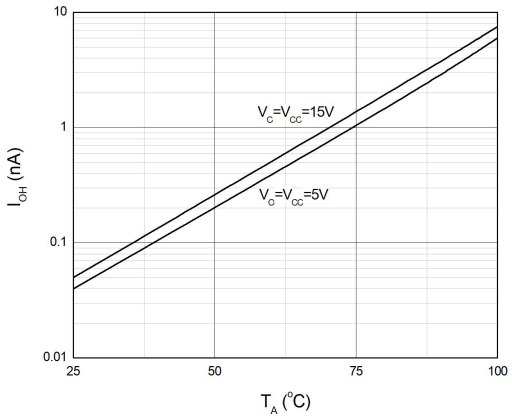


Fig.9 High Level Output Current vs. Ambient Temperature

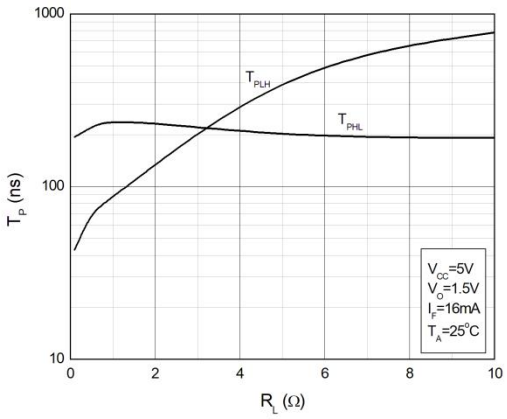


Fig.10 High Level Output Current vs. Ambient Temperature

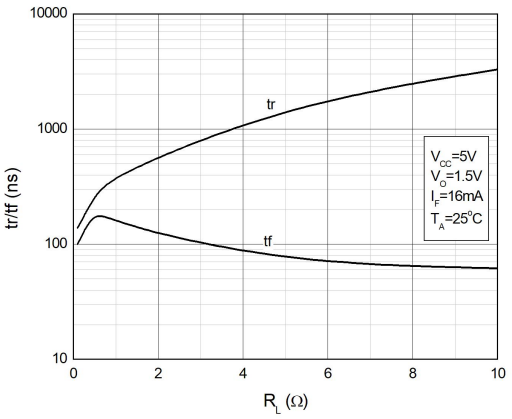


Fig.11 Output Voltage vs. Forward Current

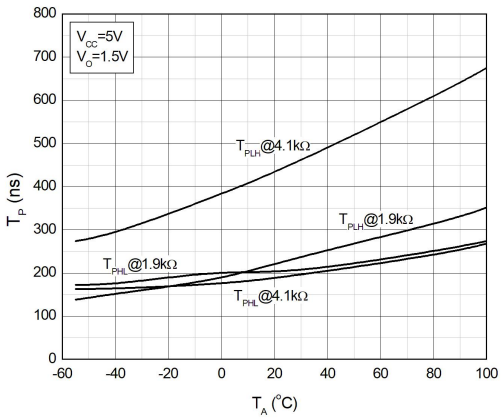
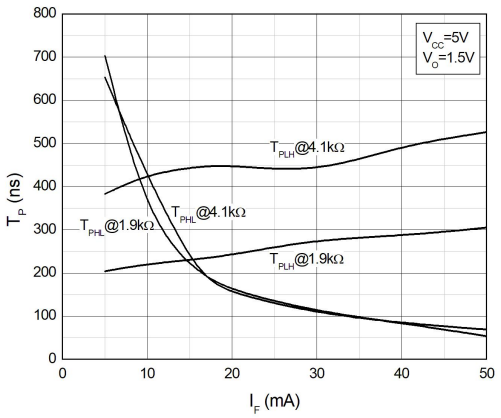


Fig.12 Output Voltage vs. Forward Current



TEST CIRCUITS

Fig.13 Test Circuits for TPHL, TPLH, tr, tf

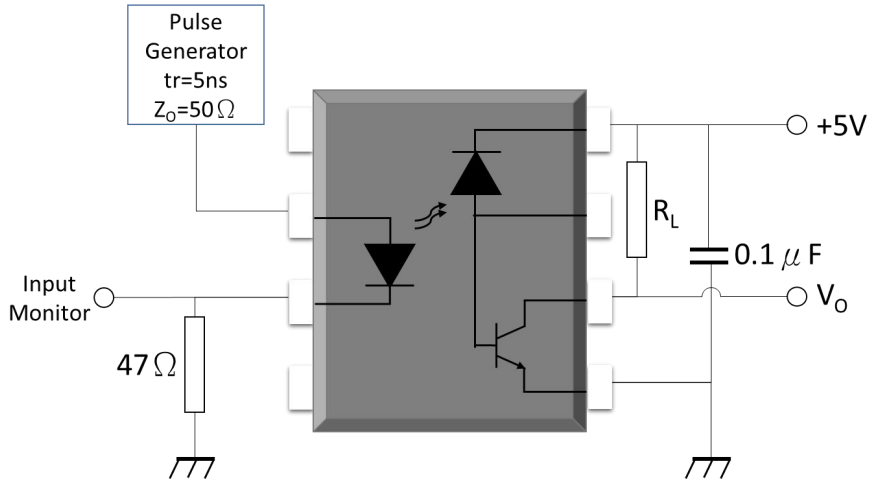
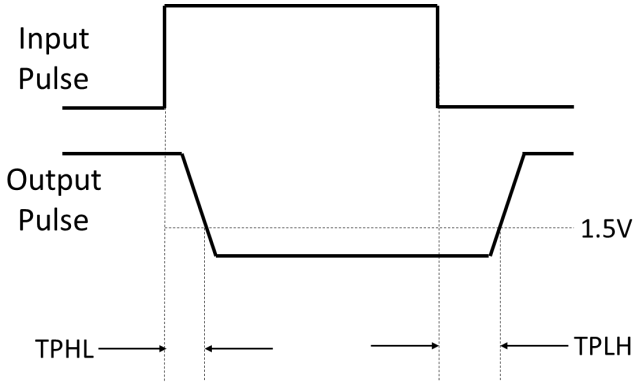
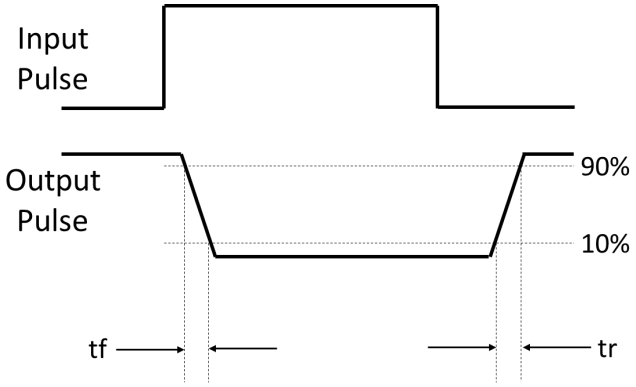


Fig.14 Waveforms of TPHL, TPLH, tr, tf





TEST CIRCUITS

Fig.15 Test Circuits for Common Mode Transient Immunity

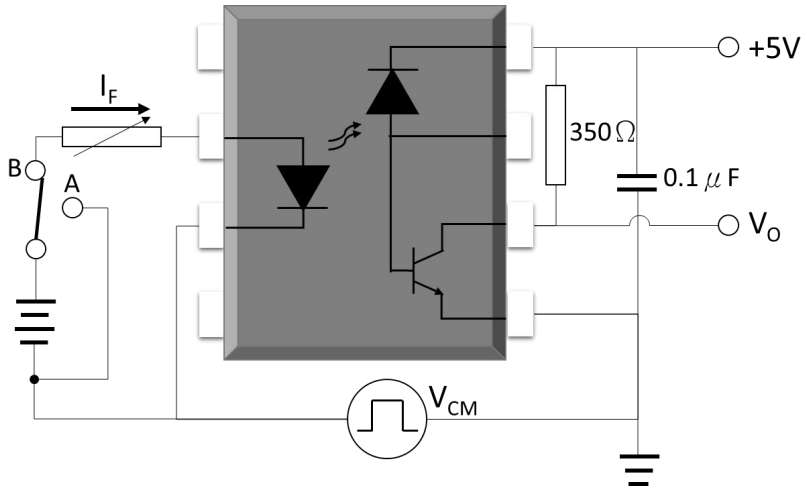
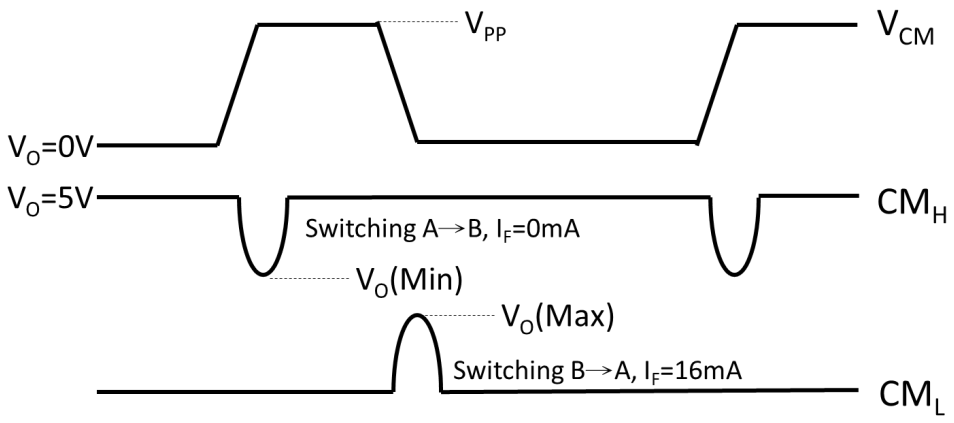
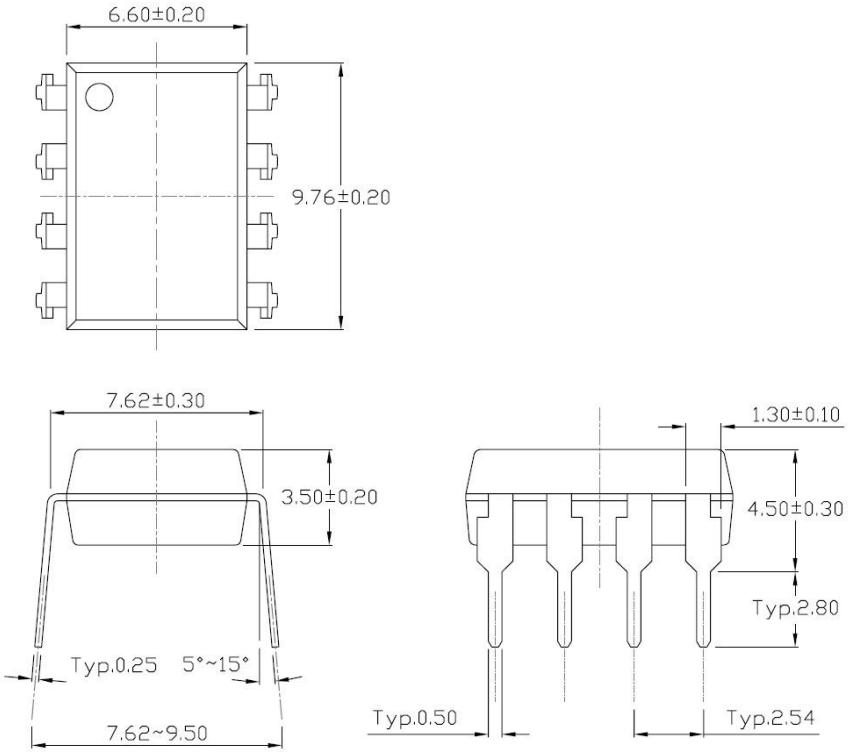


Fig.16 Waveforms of Common Mode Transient Immunity

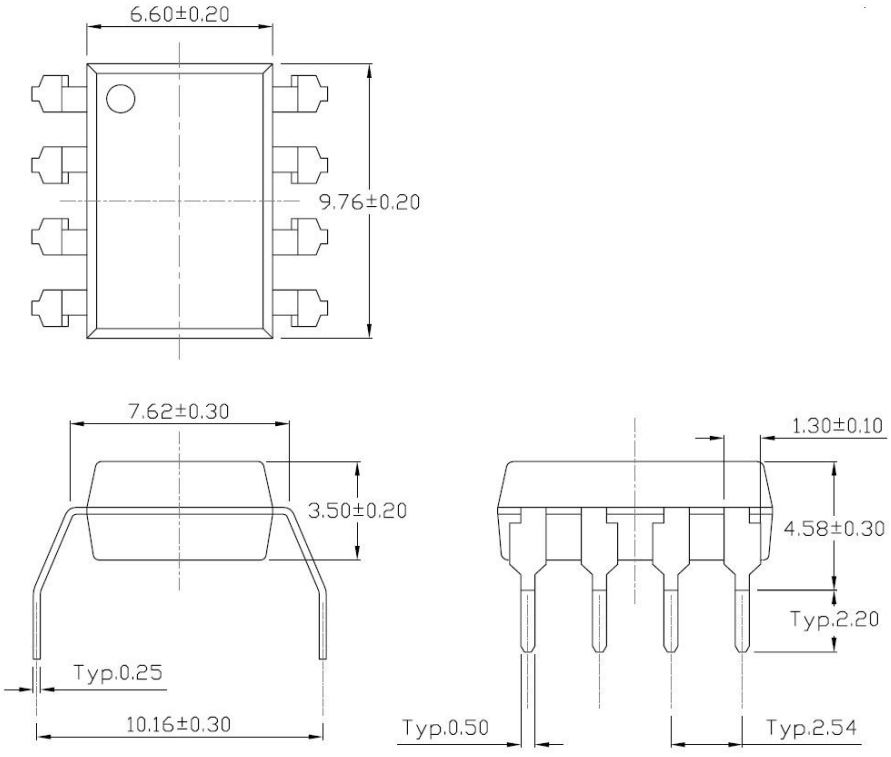


PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated)

Standard DIP – Through Hole (DIP Type)

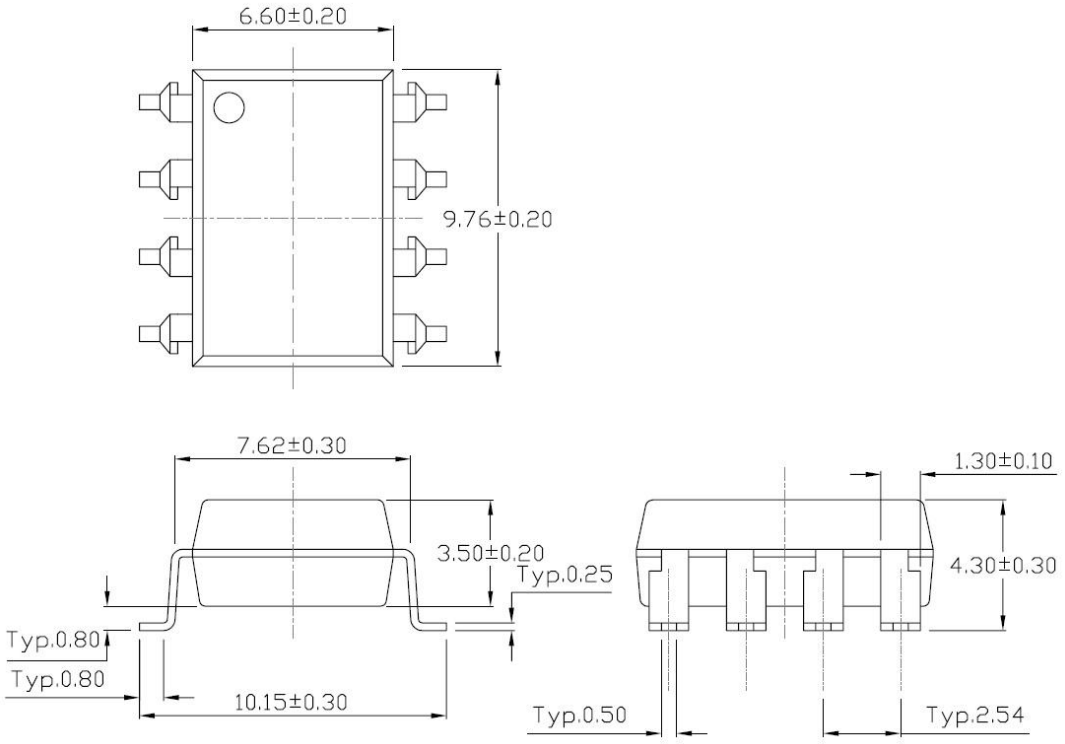


Gullwing (400mil) Lead Forming – Through Hole (M Type)

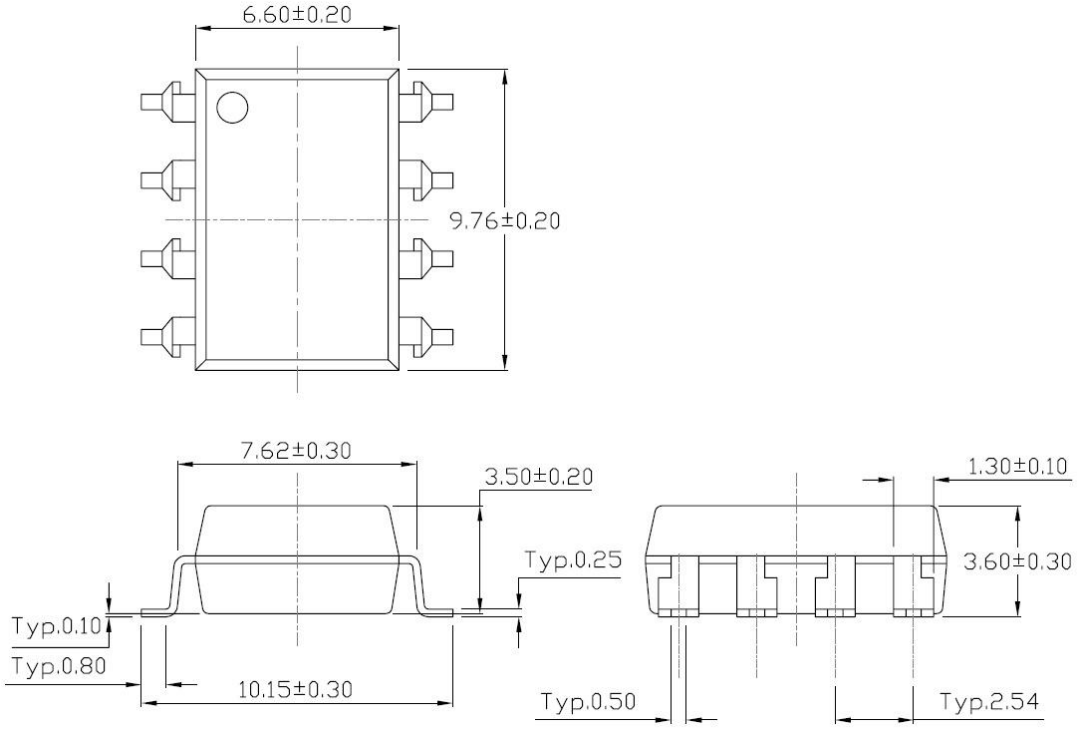


PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated)

Surface Mount Lead Forming (S Type)

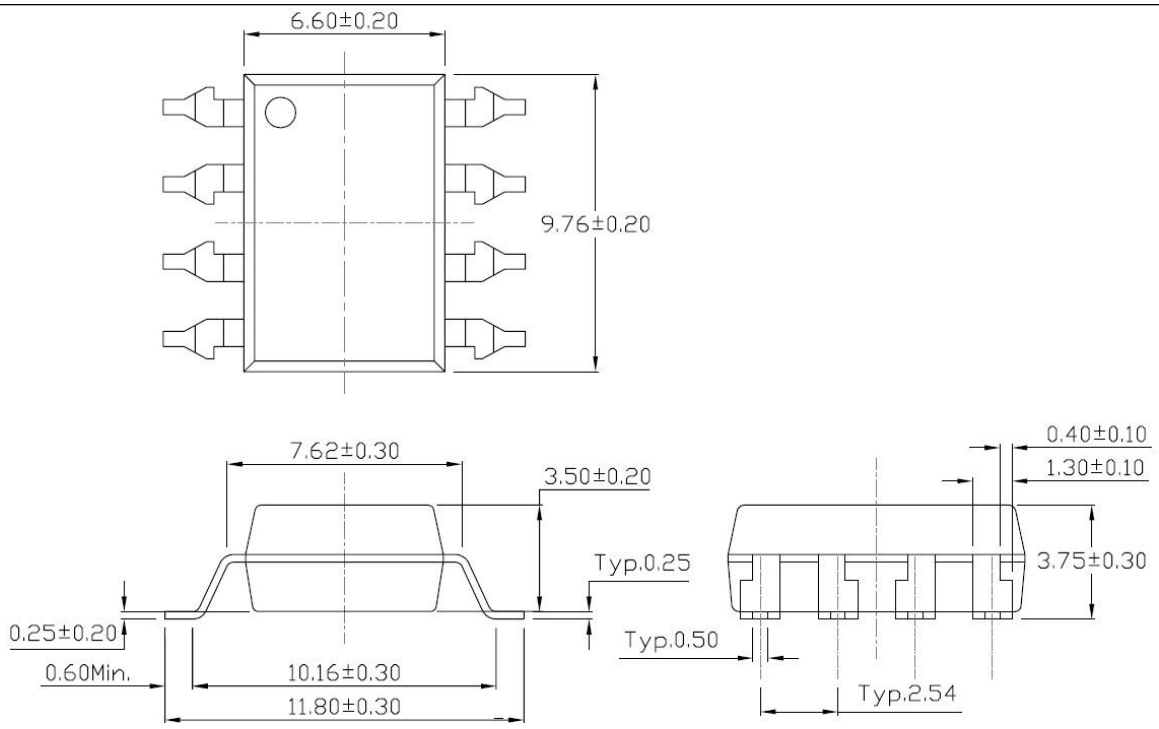


Surface Mount (Low Profile) Lead Forming (SL Type)



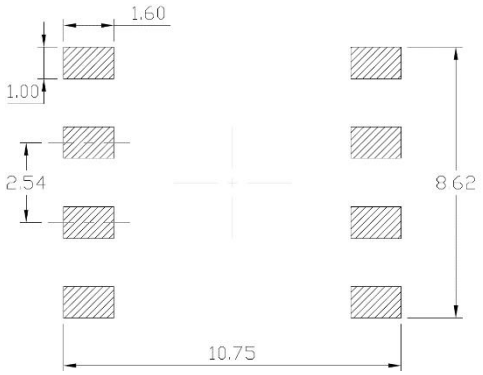
PACKAGE DIMENSIONS (Dimensions in mm unless otherwise stated)

Surface Mount (Gullwing) Lead Forming (SLM Type)

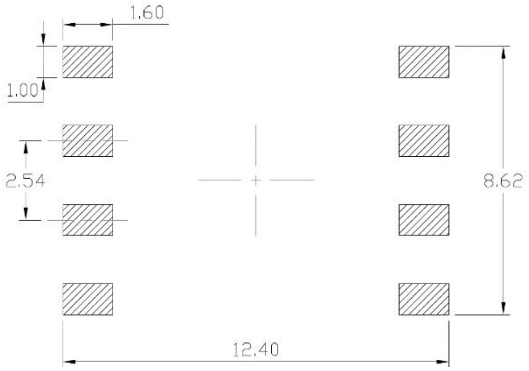


Recommended Solder Mask (Dimensions in mm unless otherwise stated)

Surface Mount Lead Forming & Surface Mount (Low Profile) Lead Forming

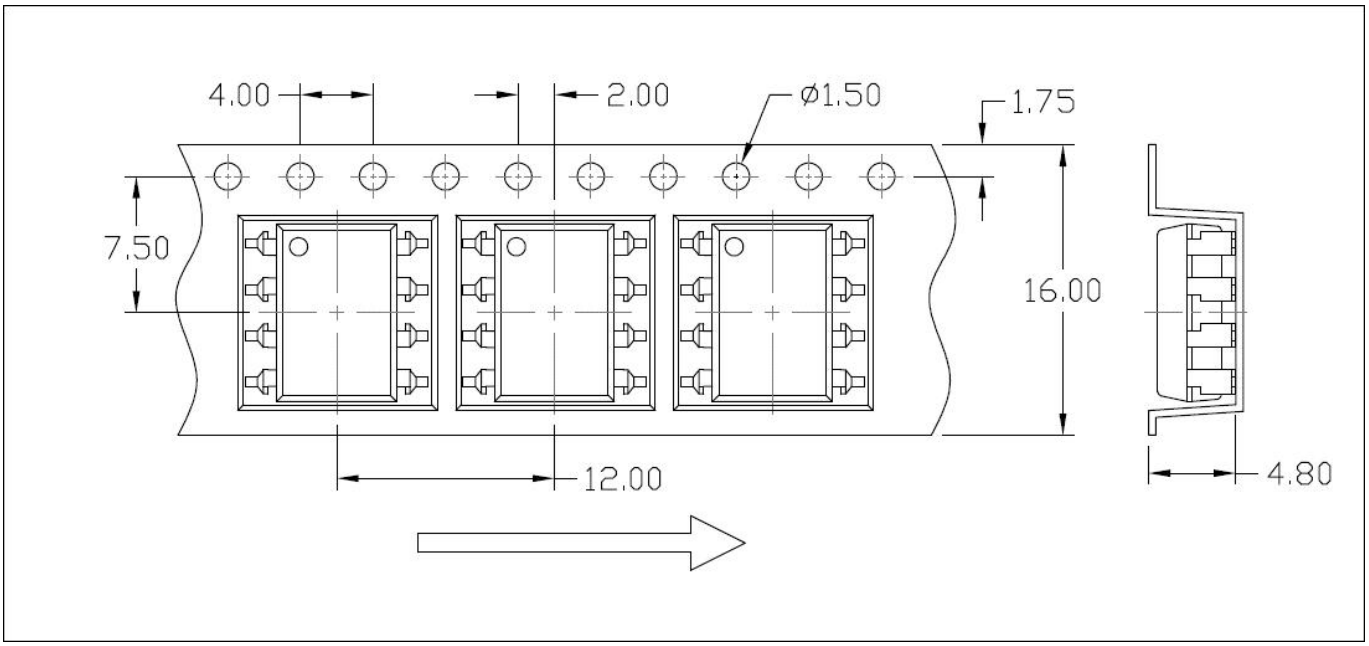


Surface Mount (Gullwing) Lead Forming

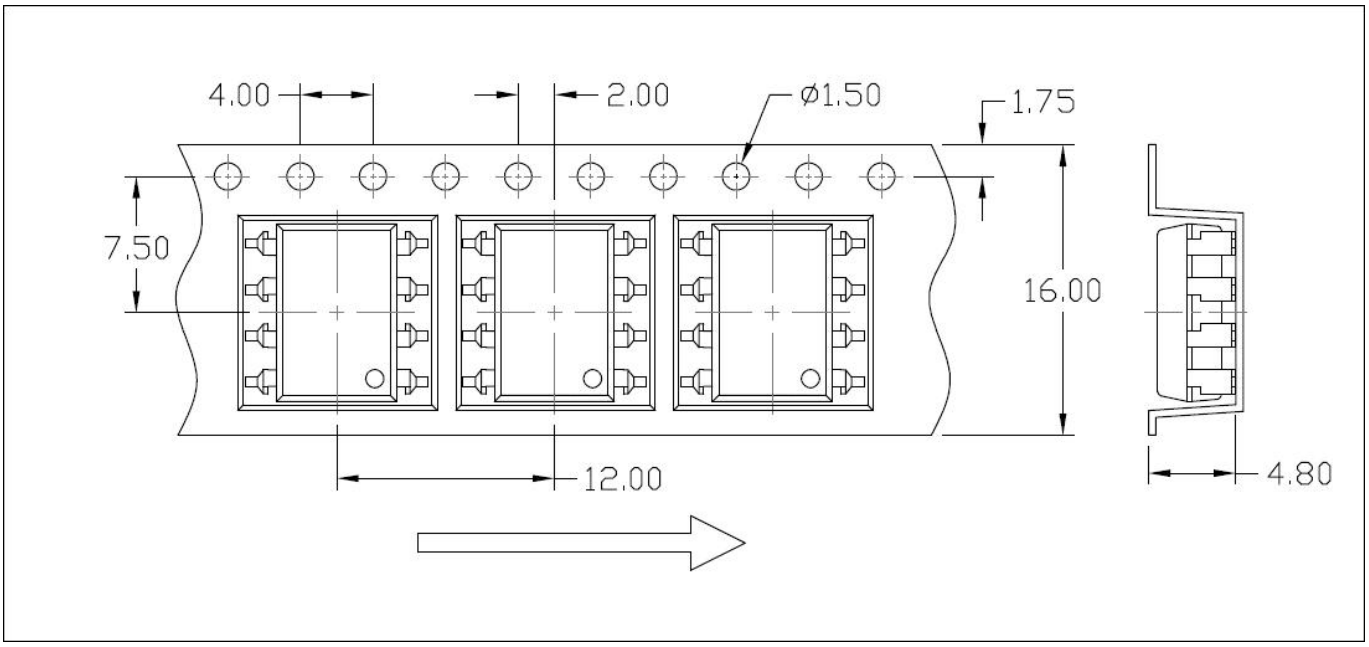


Carrier Tape Specifications (Dimensions in mm unless otherwise stated)

Option S(T1) & SL(T1)

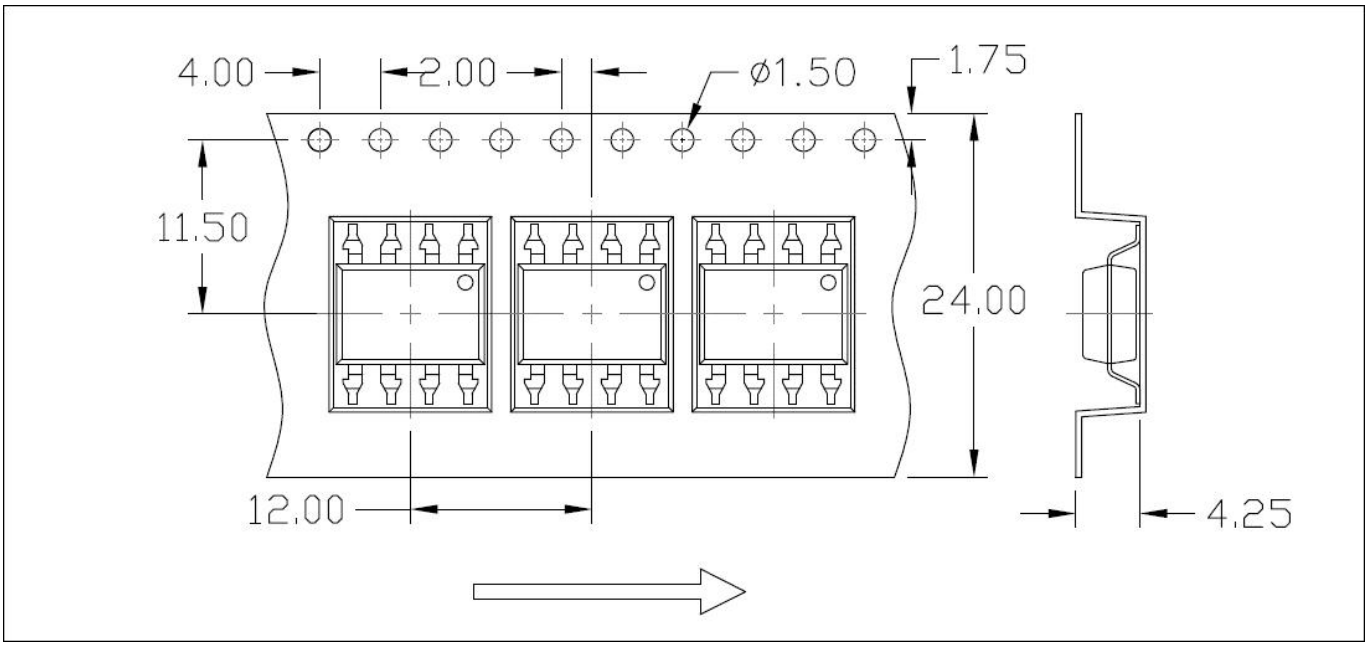


Option S(T2) & SL(T2)

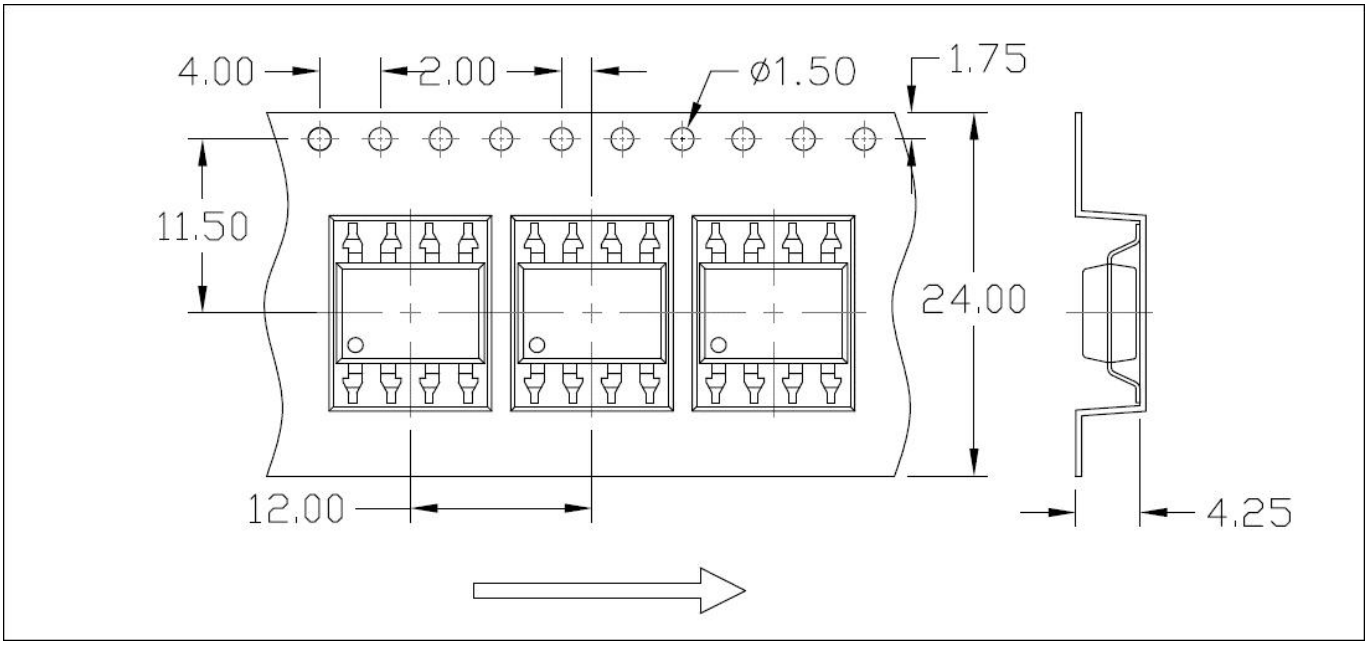


Carrier Tape Specifications (Dimensions in mm unless otherwise stated)

Option SLM(T1)

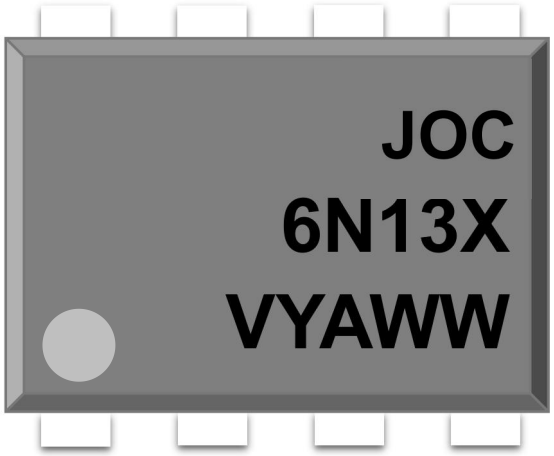


Option SLM(T2)



ORDERING AND MARKING INFORMATION

MARKING INFORMATION



JOC : Company Abbr.
6N13X : Part Number
VYAWW : LOT NO.

ORDERING INFORMATION

6N13X(Y)(Z)-GV

6N13X – Part Number (X=5 or 6)
Y – Lead Form Option
(M/S/SL/SLM/None)
Z – Tape and Reel Option (T1/T2)
G – Material Option
(G: Green, None: Non-Green)
V – VDE Option (V or None)

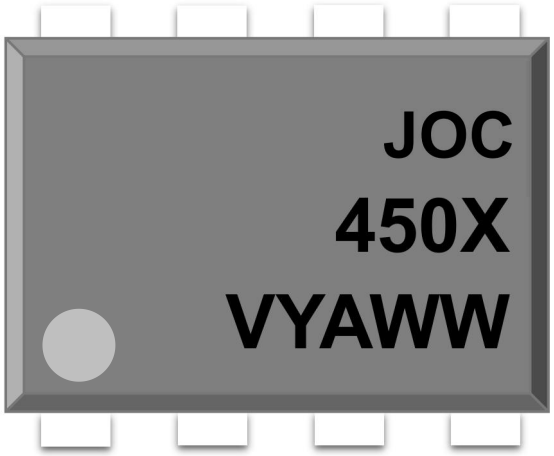
LABEL INFORMATION

PACKING QUANTITY

Option	Quantity	Quantity – Inner box	Quantity – Outer box
None	40 Units/Tube	30 Tubes/Inner box	10 Inner box/Outer box = 12k Units
M	40 Units/Tube	30 Tubes/Inner box	10 Inner box/Outer box = 12k Units
S(T1)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units
S(T2)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units
SL(T1)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units
SL(T2)	1000 Units/Reel	3 Reels/Inner box	5 Inner box/Outer box = 15k Units

ORDERING AND MARKING INFORMATION

MARKING INFORMATION



JOC : Company Abbr.
450X : Part Number & Rank
V : VDE Option
Y : Fiscal Year
A : Manufacturing Code
WW : Work Week

ORDERING INFORMATION

JOC450X(Y)(Z)-GV

JOC – Company Abbr.
450X – Rank (X=2 or 3)
Y – Lead Form Option
(M/S/SL/SLM/None)
Z – Tape and Reel Option (T1/T2)
G – Material Option
(G: Green, None: Non-Green)
V – VDE Option (V or None)

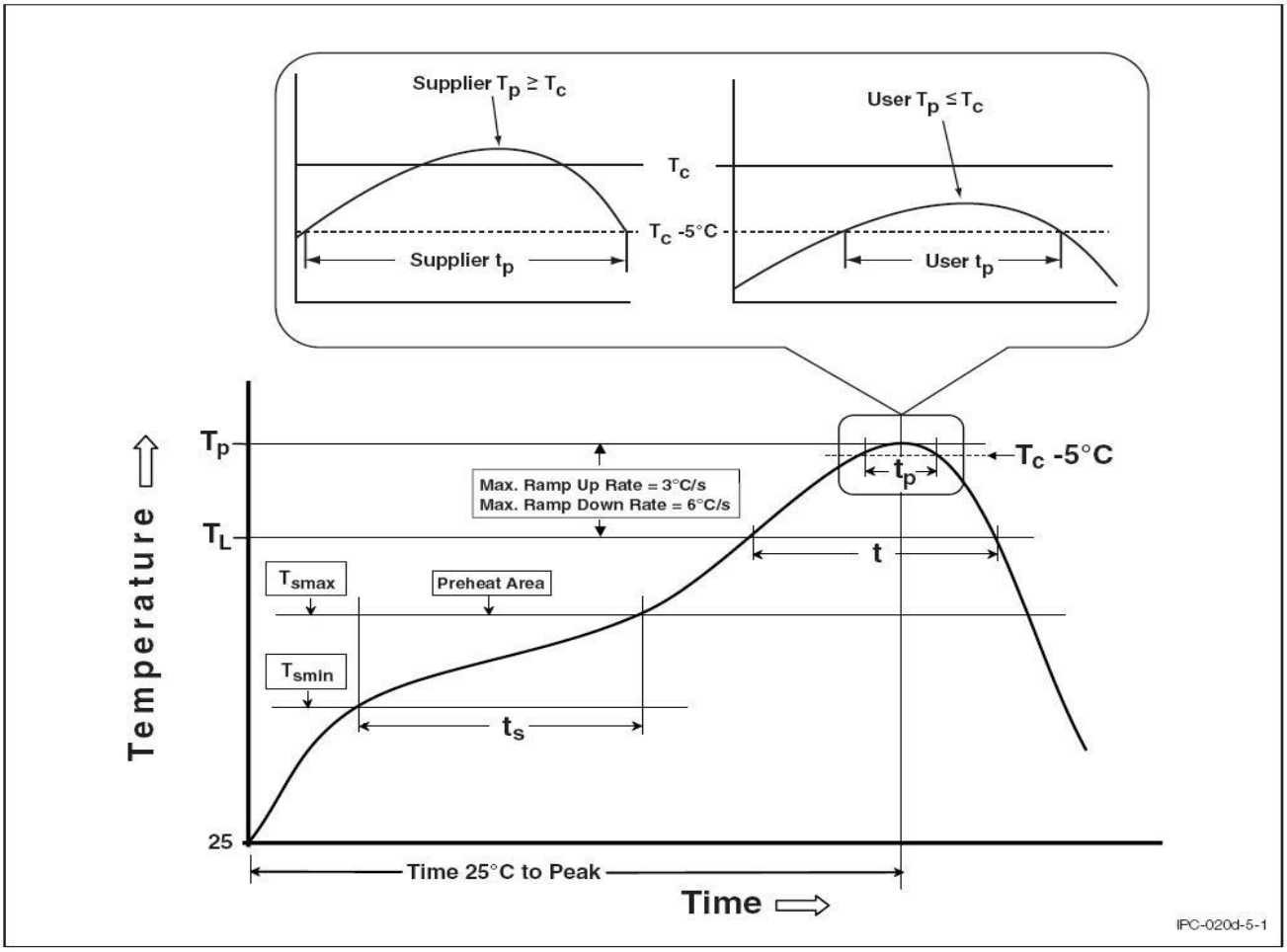
LABEL INFORMATION

PACKING QUANTITY

Option	Quantity		
None			
M			
S(T1)			
S(T2)			
SL(T1)			
SL(T2)			

REFLOW INFORMATION

REFLOW PROFILE



Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	100	150°C
Temperature Max. (Tsmax)	150	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds	60-120 seconds
Ramp-up Rate (tL to tP)	3°C/second max.	3°C/second max.
Liquidous Temperature (TL)	183°C	217°C
Time (tL) Maintained Above (TL)	60 – 150 seconds	60 – 150 seconds
Peak Body Package Temperature	235°C +0°C / -5°C	260°C +0°C / -5°C
Time (tP) within 5°C of 260°C	20 seconds	30 seconds
Ramp-down Rate (TP to TL)	6°C/second max	6°C/second max
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.

DISCLAIMER

- JIEJIE is continually improving the quality, reliability, function and design. JIEJIE reserves the right to make changes without further notices.
- The characteristic curves shown in this datasheet are representing typical performance which are not guaranteed.
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